

Electronic Patent Application Fee Transmittal

Application Number:	10521287			
Filing Date:	08-Aug-2005			
Title of Invention:	Silicone-based adhesive sheet, method of bonding a semiconductor chip to a chip attachment component, and a semiconductor device			
First Named Inventor/Applicant Name:	Manabu Sutoh			
Filer:	David Michael LaPrairie/Diane Jerome			
Attorney Docket Number:	71,051-001			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				810